

# Abstracts

## COM2 enhanced graded base SiGe technology for high speed applications (2002 [RFIC])

*T. Ivanov, M. Carroll, S. Moinian, M. Mastrapasqua, A. Frei, A. Chen, C. King, A. Hamad, E. Martin, S. Shive, T. Esry, C. Lee, R. Johnson, T. Sorsch, K. Banoo, P. Smith and W. Cochran.*

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The COM2 Enhanced Graded Base SiGe modular BiCMOS technology has been developed. It is based on the COM2 digital CMOS process. The technology achieves peak  $F_t=100$  GHz, peak  $F_{max}=101$  GHz, peak  $/spl\beta/=186$  and  $BV_{cex}=2.05$  V.  $F_t \cdot BV_{cex}$  product of 205 and good across wafer uniformity are demonstrated.

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